

ILC5062

SOT-23 Power Supply reset Monitor with 1% precision

Features

- All-CMOS design in SOT-23 or SC70 package
- A grade $\pm 1\%$ precision in Reset Detection
- Standard grade : $\pm 2\%$ precision in Reset Detection
- Only $1\mu\text{A}$ of I_q
- Over 2mA of sink current capability
- Built-in hysteresis of 5% of detection voltage
- Voltage options of 2.6, 2.7, 2.8, 2.9, 3.1, 4.4, and 4.6V fit most supervisory applications
- Active low push-pull output

Applications

- Microprocessor reset circuits
- Memory battery back-up circuitry
- Power-on reset circuits
- Portable and battery powered electronics

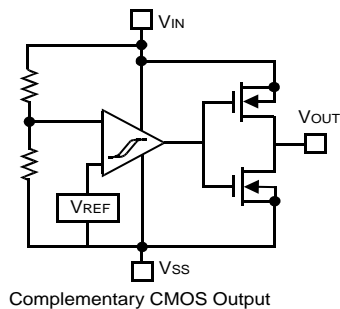
Description

All-CMOS voltage monitoring circuit in either a 3-lead SOT-23 or SC70 package offers the best performance in power consumption and accuracy.

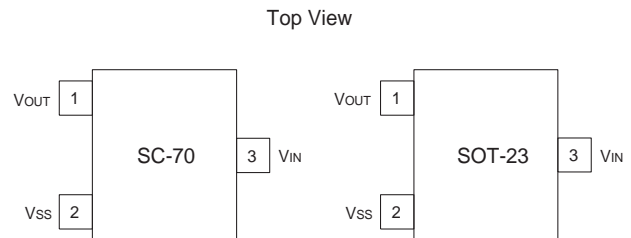
The ILC5062 is available in a series of $\pm 1\%$ (A-grade) or 2% (standard grade) accurate trip voltages to fit most microprocessor applications. Even though its output can sink over 2mA , the device draws only $1\mu\text{A}$ in normal operation.

Additionally, a built-in hysteresis of 5% of detect voltage simplifies system design.

Block Diagram



Pin-Package Configurations



Absolute Maximum Ratings

Parameter	Symbol	Ratings	Units
Input Voltage	V_{IN}	12	V
Output Current	I_{OUT}	50	mA
Output Voltage	V_{OUT}	$V_{SS}-0.3\sim V_{IN}+0.3$	V
Continuous Total Power Dissipation (SOT-23)	P_D	150	mW
Operating Ambient Temperature	T_{opr}	-30~+80	°C
Storage Temperature	T_{stg}	-40~+125	°C

Electrical Characteristics ILC5062 ($T_A=25^\circ\text{C}$)

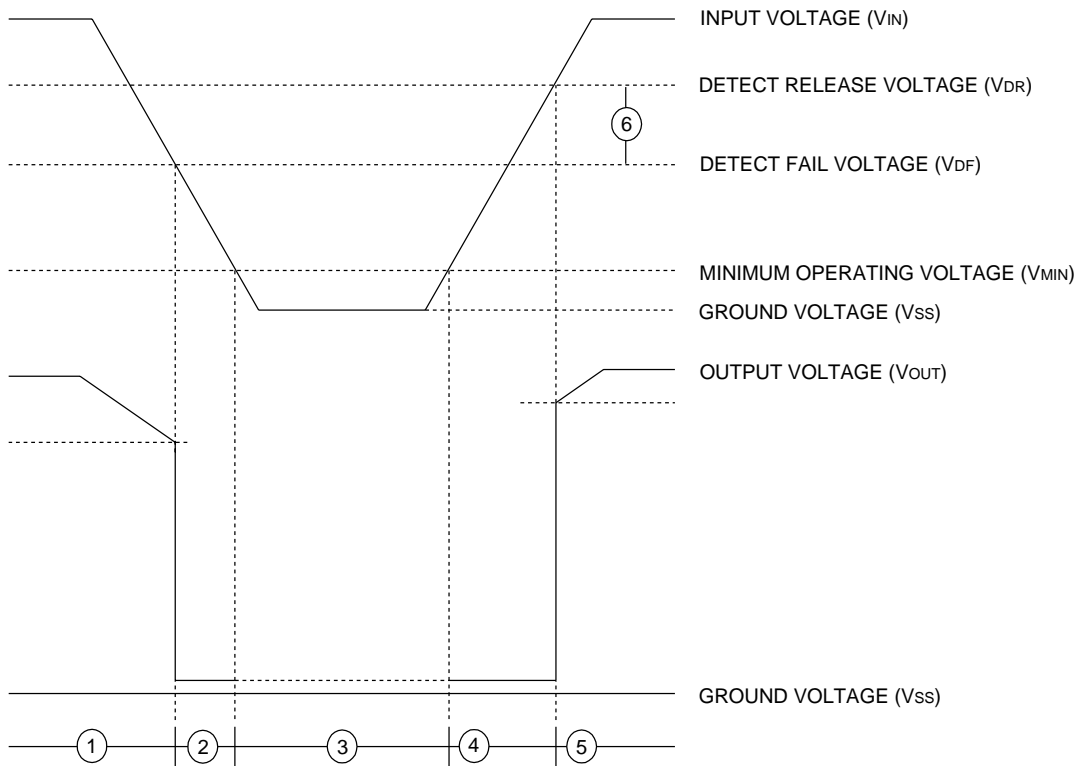
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Detect Fail Voltage	V_{DF}	A grade	$V_{DF} \times 0.99$	V_{DF}	$V_{DF} \times 1.01$	V
Detect Fail Voltage	V_{DF}	Standard grade	$V_{DF} \times 0.98$	V_{DF}	$V_{DF} \times 1.02$	V
Hysteresis Range	V_{HYS}		$V_{DF} \times 0.02$	$V_{DF} \times 0.05$	$V_{DF} \times 0.08$	V
Supply Current	I_{SS}	$V_{IN} = 1.5\text{V}$ $V_{IN} = 2.0\text{V}$ $V_{IN} = 3.0\text{V}$ $V_{IN} = 4.0\text{V}$ $V_{IN} = 5.0\text{V}$		0.9 1.0 1.3 1.6 2.0	2.6 3.0 3.4 3.8 4.2	μA
Operating Voltage	V_{IN}	$V_{DF} = 2.1 \sim 6.0\text{V}$	1.5		10.0	V
Output Current	I_{OUT}	N-ch $V_{DS} = 0.5\text{V}$ $V_{IN} = 1.0\text{V}$ $V_{IN} = 2.0\text{V}$ $V_{IN} = 3.0\text{V}$ $V_{IN} = 4.0\text{V}$ $V_{IN} = 5.0\text{V}$ P-Ch $V_{DS} = 2.1\text{V}$ $V_{IN} = 8\text{V}$		2.2 7.7 10.1 11.5 13.0 -10		mA
Temperature Characteristics	$\Delta V_{DF}/(\Delta T_{opr} \cdot V_{DF})$	$-30^\circ\text{C} \leq T_{opr} \leq 80^\circ\text{C}$	-200	± 100	+200	ppm/°C
Delay Time (Release Voltage \rightarrow Output Inversion)	t_{DLY} (V_{DR} to V_{OUT} Inversion)				0.1	ms

Note: An additional resistor between the V_{IN} pin and supply voltage may cause deterioration of the characteristics due to increasing of V_{DR} .

Functional Description

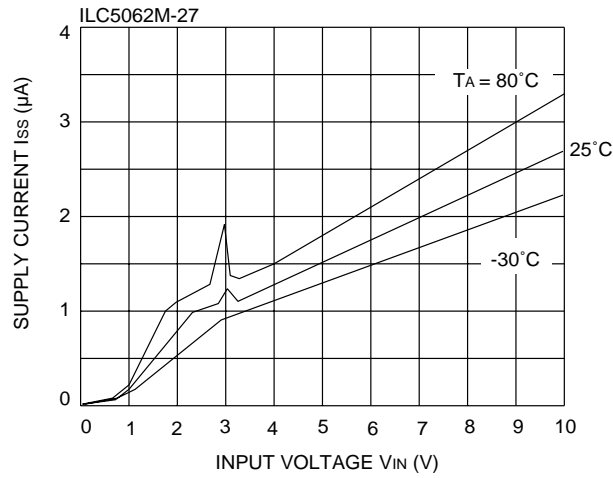
The following designators 1~6 refer to the timing diagram below.

1. While the input voltage (V_{IN}) is higher than the detect voltage (V_{DF}), the output voltage at V_{OUT} pin equals the input voltage at V_{IN} pin.
2. When the input V_{IN} voltage falls lower than V_{DF} , V_{OUT} drops near ground voltage.
3. If the input voltage decreases below the minimum operating voltage (V_{MIN}), the V_{OUT} output voltage will be undefined.
4. During an increase of the input voltage from the V_{SS} voltage, V_{OUT} is undefined at the voltage below V_{MIN} . Exceeding the V_{MIN} level, the output stays at the ground level (V_{SS}) between the minimum operating voltage (V_{MIN}) and the detect release voltage (V_{DR}).
5. If the input voltage increases more than V_{DR} , the output voltage at V_{OUT} pin equals the input voltage at V_{IN} pin.
6. The difference between V_{DR} and V_{DF} is the hysteresis in the system.

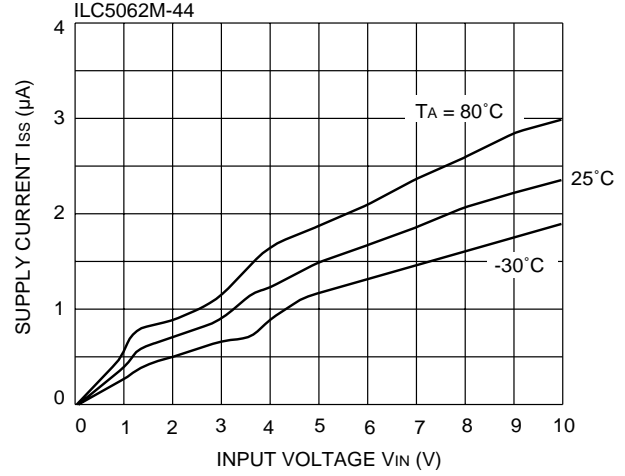


Typical Performance Characteristics - General conditions for all curves

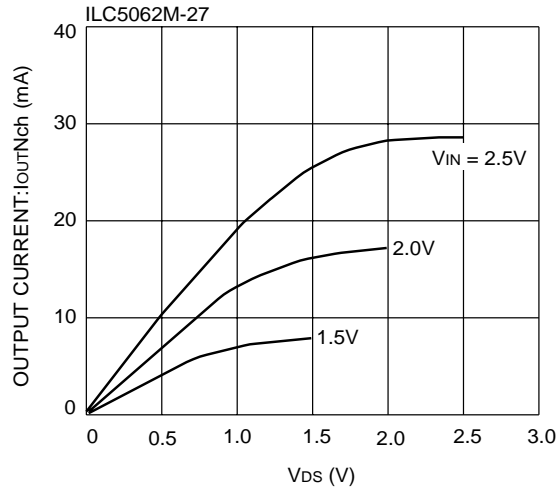
Supply Current vs Input Voltage



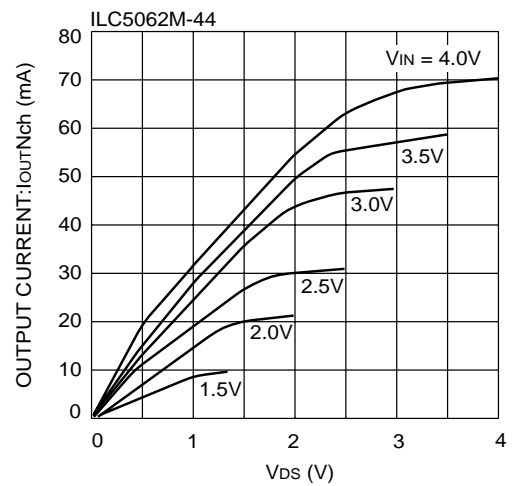
Supply Current vs Input Voltage



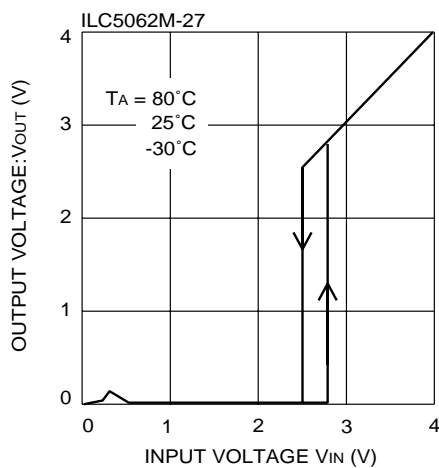
N-ch Driver Output Current vs Vds



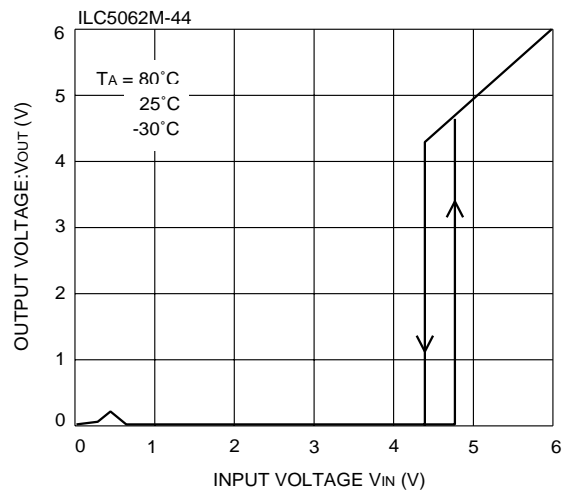
N-ch Driver Output Current vs Vds



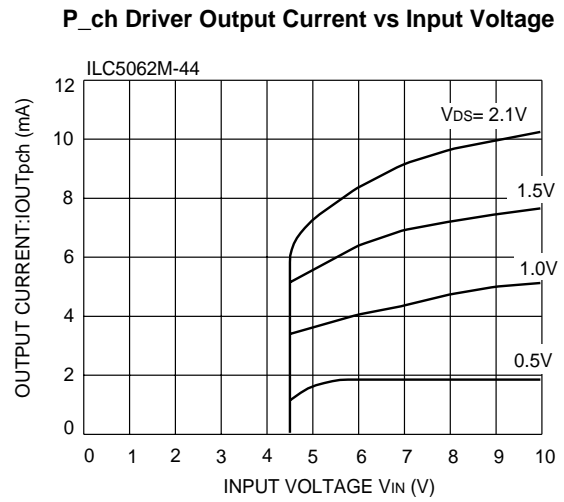
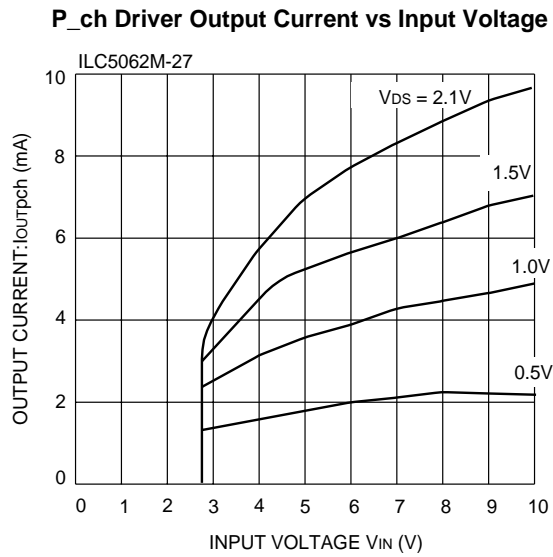
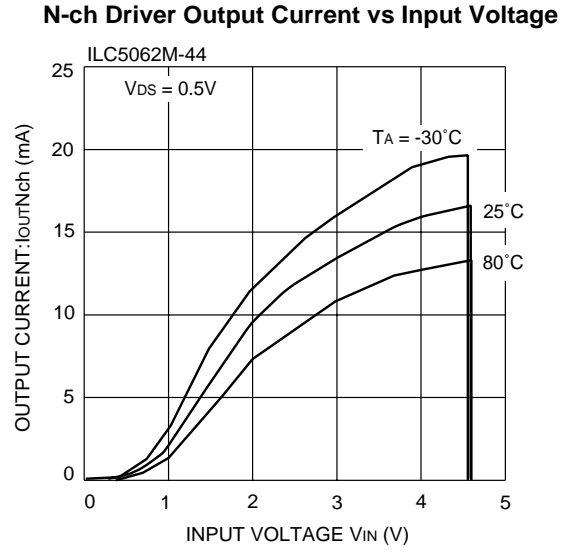
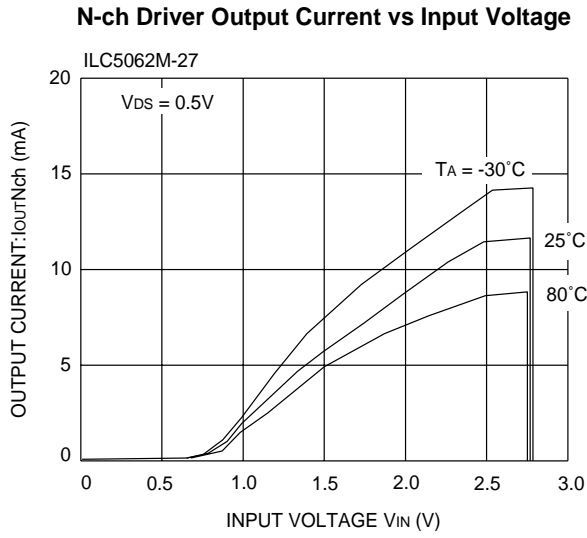
Vout vs Vin



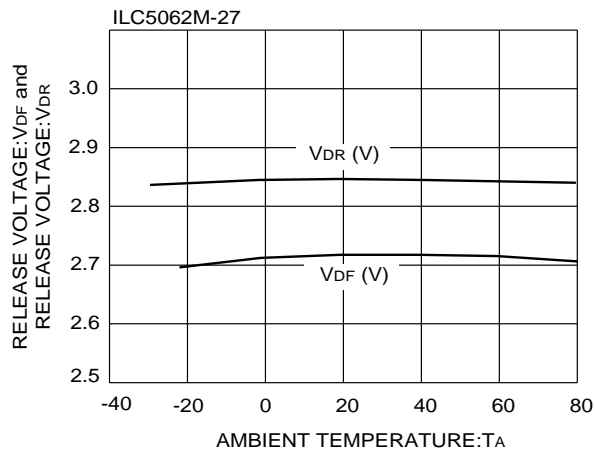
Vout vs Vin



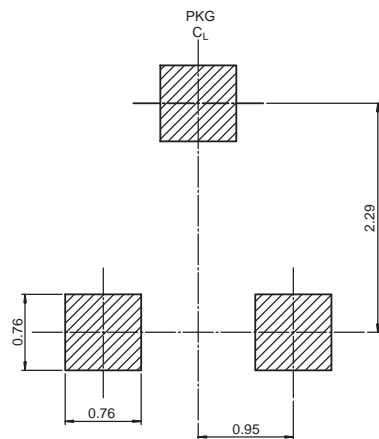
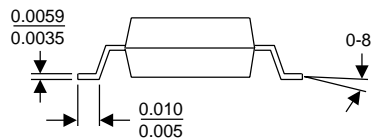
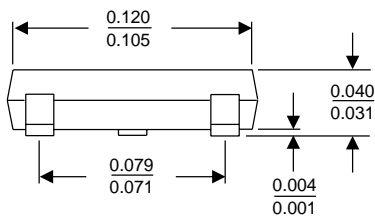
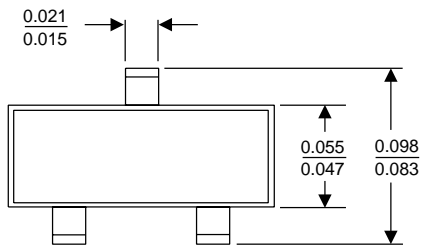
Typical Performance Characteristics - General conditions for all curves



VDR and VDF vs Temperature

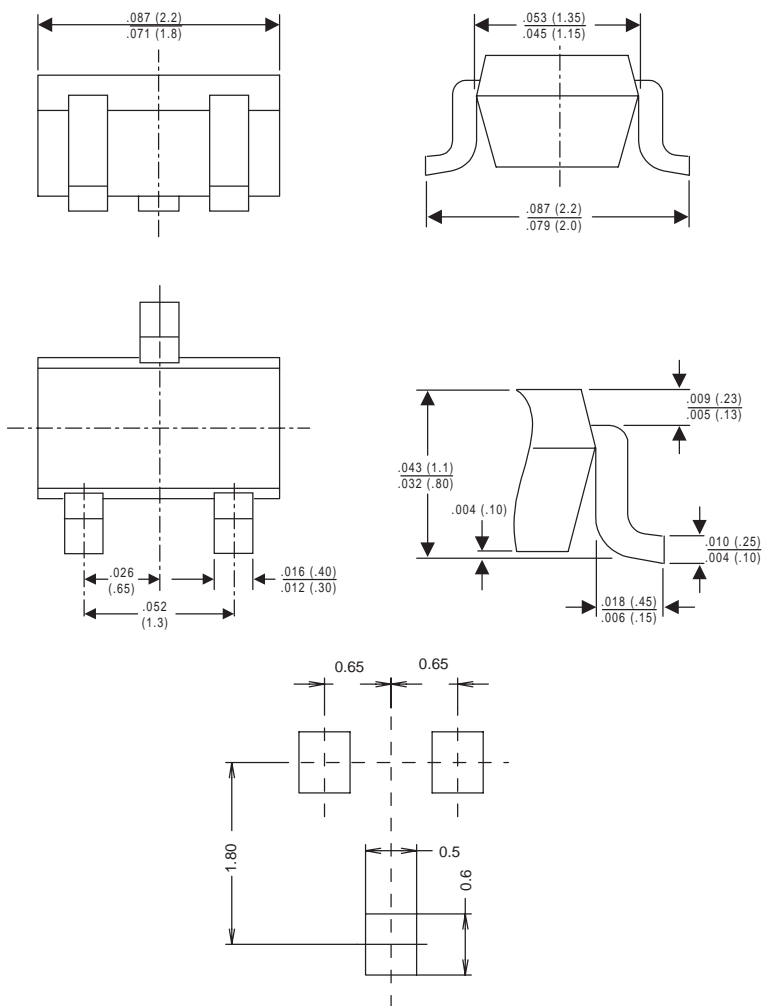


SOT-23



LAND PATTERN RECOMMENDATION

SC70



Land Pattern Recommendation

Ordering Information

PART NUMBER	TOP MARKING	RESET THRESHOLD (V)	OUTPUT TYPE	PACKAGE	PACKING METHOD
ILC5062AM23	C3AY	2.3 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM25	C5AY	2.5 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM26	C6AY	2.6 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM27	C7AY	2.7 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM28	C8AY	2.8 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM29	C9AY	2.9 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM30	D0AY	3.0 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM31	D1AY	3.1 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM37	D7AY	3.7 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM44	E4AY	4.4 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AM46	E6AY	4.6 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M23	C3Y	2.3 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M25	C5Y	2.5 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M26	C6Y	2.6 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M27	C7Y	2.7 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M28	C8Y	2.8 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M29	C9Y	2.9 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M30	D0Y	3.0 ± 1%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M31	D1Y	3.1 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M37	D7Y	3.7 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M44	E4Y	4.4 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062M46	E6Y	4.6 ± 2%	Push-Pull, active LOW	3-Pin, SOT23	3000 units in T&R
ILC5062AIC23	C3AY	2.3 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC25	C5AY	2.5 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC26	C6AY	2.6 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC27	C7AY	2.7 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC28	C8AY	2.8 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC29	C9AY	2.9 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC30	D0AY	3.0 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC31	D1AY	3.1 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC37	D7AY	3.7 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC44	E4AY	4.4 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062AIC46	E6AY	4.6 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC23	C3Y	2.3 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC25	C5Y	2.5 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC26	C6Y	2.6 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC27	C7Y	2.7 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC28	C8Y	2.8 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC29	C9Y	2.9 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC30	D0Y	3.0 ± 1%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC31	D1Y	3.1 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC37	D7Y	3.7 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC44	E4Y	4.4 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R
ILC5062IC46	E6Y	4.6 ± 2%	Push-Pull, active LOW	3-Pin, SC70	3000 units in T&R

Note 1: Last digit in the "Top Marking" information (represented by "Y" in the above table) represents internal assembly lot number

Note 2: Orientation of Tape & Reeled devices is Right.

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.